



# 30A, 100V - 120V Low V<sub>F</sub> Trench Schottky Rectifier

#### **FEATURES**

- Patented Trench Schottky technology
- Excellent high temperature stability
- Low forward voltage
- Low power loss/ high efficiency
- High forward surge capability
- Compliant RoHS
- Halogen-free according to IEC 61249-2-21

#### **APPLICATIONS**

- Switching mode power supply (SMPS)
- Adapters
- Lighting application
- On-board DC/DC converter

#### **MECHANICAL DATA**

• Case: ITO-220AB

Molding compound meets UL 94V-0 flammability rating

• Terminal: Matte tin plated leads, solderable per J-STD-002

• Meet JESD 201 class 2 whisker test

Mounting torque: 0.56 N⋅m maximum

• Polarity: As marked

• Weight: 1.70g (approximately)

KEY PARAMETERS				
PARAMETER	VALUE	UNIT		
I <sub>F</sub>	30	Α		
$V_{RRM}$	100 -120	V		
I <sub>FSM</sub>	160	Α		
T <sub>J MAX</sub>	150	°C		
Package	ITO-220AB			
Configuration	Dual dies			





PIN1 O PIN2
O Cathode

**ITO-220AB** 

ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)				
PARAMETER	SYMBOL	TSF30U100C	TSF30U120C	UNIT
Marking code on the device		TSF30U100C	TSF30U120C	
Repetitive peak reverse voltage	$V_{RRM}$	100	120	V
Reverse voltage, total rms value	$V_{R(RMS)}$	70	84	V
Isolation voltage from terminal to heatsink t = 1 min	$V_{AC}$	1500		V
Forward current	l <sub>F</sub>	30		Α
Surge peak forward current, 8.3ms single half sinewave superimposed on rated load	I <sub>FSM</sub>	160		Α
Critical rate of rise of off-state voltage	dv/dt	10,000		V/µs
Junction temperature	TJ	-55 to +150		°C
Storage temperature	T <sub>STG</sub>	-55 to +150		°C

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THERMAL PERFORMANCE					
PARAMETER		SYMBOL	TYP	UNIT	
Junction-to-case thermal resistance	TSF30U100C	$R_{\Theta,IC}$	2.5	°C/W	
	TSF30U120C		3.5	°C/W	

PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
FARAMETER	TOFOOLIAGOO		JIMBOL		WAX	
	TSF30U100C	II5∧ T25°C I		0.52	-	V
	TSF30U120C			0.56	-	V
Forward voltage per diode <sup>(1)</sup>	TSF30U100C	I <sub>F</sub> = 7.5A, T <sub>J</sub> = 25°C	V <sub>F</sub>	0.56	-	V
	TSF30U120C			0.65	-	V
	TSF30U100C	1 15A T 05°C		0.66	0.74	V
	TSF30U120C	$I_F = 15A, T_J = 25^{\circ}C$		0.78	0.88	V
	TSF30U100C	L EAT 105°C		0.44	-	V
	TSF30U120C	$I_F = 5A, T_J = 125$ °C		0.49	-	V
	TSF30U100C	I <sub>F</sub> = 7.5A, T <sub>J</sub> = 125°C		0.51	-	V
	TSF30U120C			0.56	-	V
	TSF30U100C	I <sub>F</sub> = 15A, T <sub>J</sub> = 125°C		0.60	0.67	V
	TSF30U120C			0.65	0.75	V
Reverse current @ rated V <sub>R</sub> per diode <sup>(2)</sup>		$T_J = 25^{\circ}C$	- I <sub>R</sub>	-	500	μΑ
		T <sub>J</sub> = 125°C		-	35	mA

## Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION			
ORDERING CODE <sup>(1)</sup>	PACKAGE	PACKING	
TSF30UxC	ITO-220AB	50 / Tube	

#### Notes:

1. "x" defines voltage from 100V(TSF30U100C) to 120V(TSF30U120C)



## **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

Fig.1 Forward Current Derating Curve

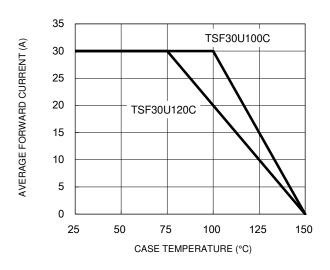


Fig.3 Typical Reverse Characteristics

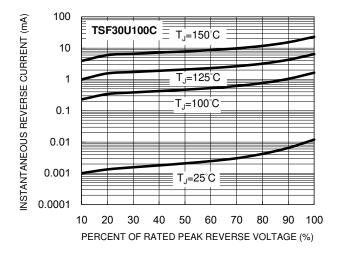


Fig.5 Typical Reverse Characteristics

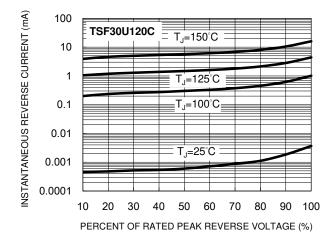


Fig.2 Typical Junction Capacitance

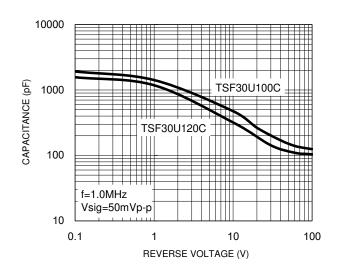


Fig.4 Typical Forward Characteristics

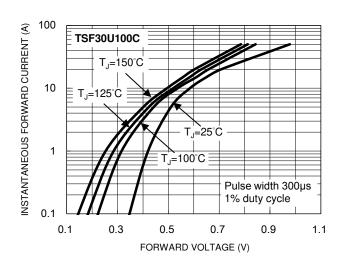
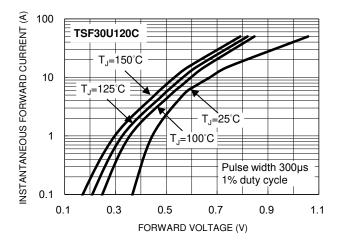


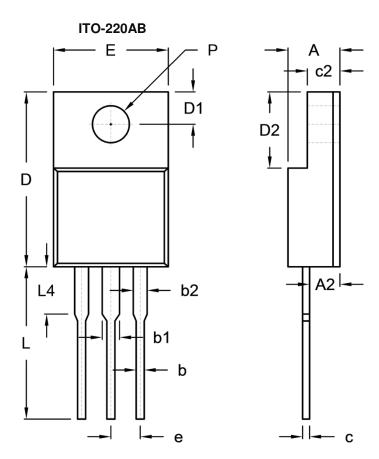
Fig.6 Typical Forward Characteristics





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## **PACKAGE OUTLINE DIMENSIONS**



DIM.	Unit	(mm)	Unit (inch)		
Dilvi.	Min.	Max.	Min.	Max.	
Α	4.30	4.70	0.169	0.185	
A2	2.30	2.96	0.091	0.117	
b	0.50	0.90	0.020	0.035	
b1	-	1.80	-	0.071	
b2	0.95	1.45	0.037	0.057	
С	0.46	0.76	0.018	0.030	
c2	2.50	3.16	0.098	0.124	
D	14.80	15.50	0.583	0.610	
D1	2.40	3.20	0.094	0.126	
D2	6.30	6.90	0.248	0.272	
E	9.60	10.30	0.378	0.406	
е	2.41	2.67	0.095	0.105	
L	12.60	13.80	0.496	0.543	
L4	-	4.10	-	0.161	
Р	3.00	3.40	0.118	0.134	

## **MARKING DIAGRAM**



P/N = Marking Code G = Green Compound

YWW = Date Code F = Factory Code



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